



**SPECIFICATION**

**Electrical :**

- 1.Current Rating: 0.5A
- 2.Voltage Rating: 5V AC/DC
- 3.Contact Resistance: 100 mΩ Max.
- 4.Insulation Resistance: 1000 MΩ Min.

**Environmental:**

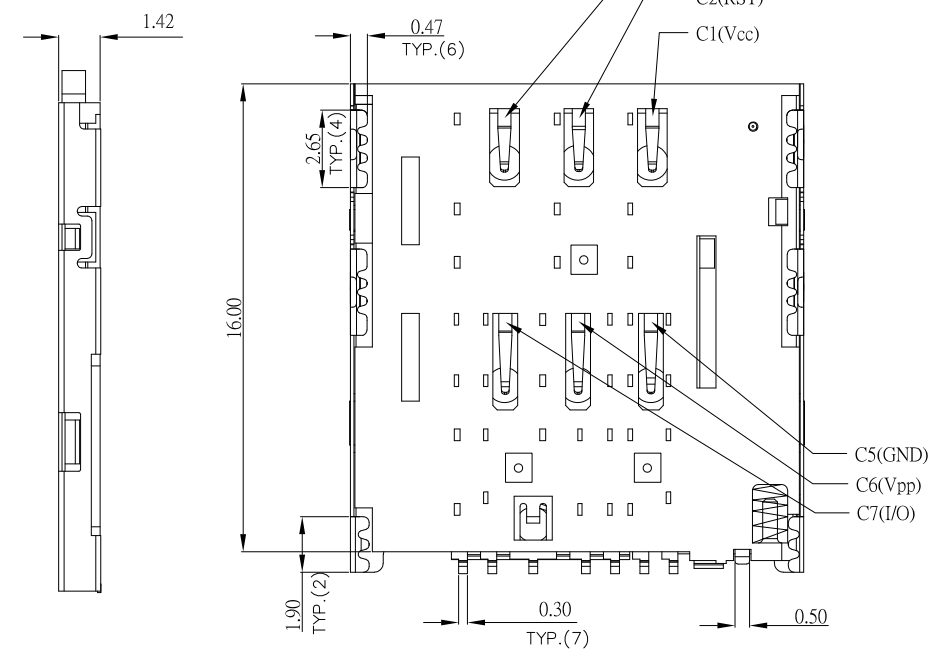
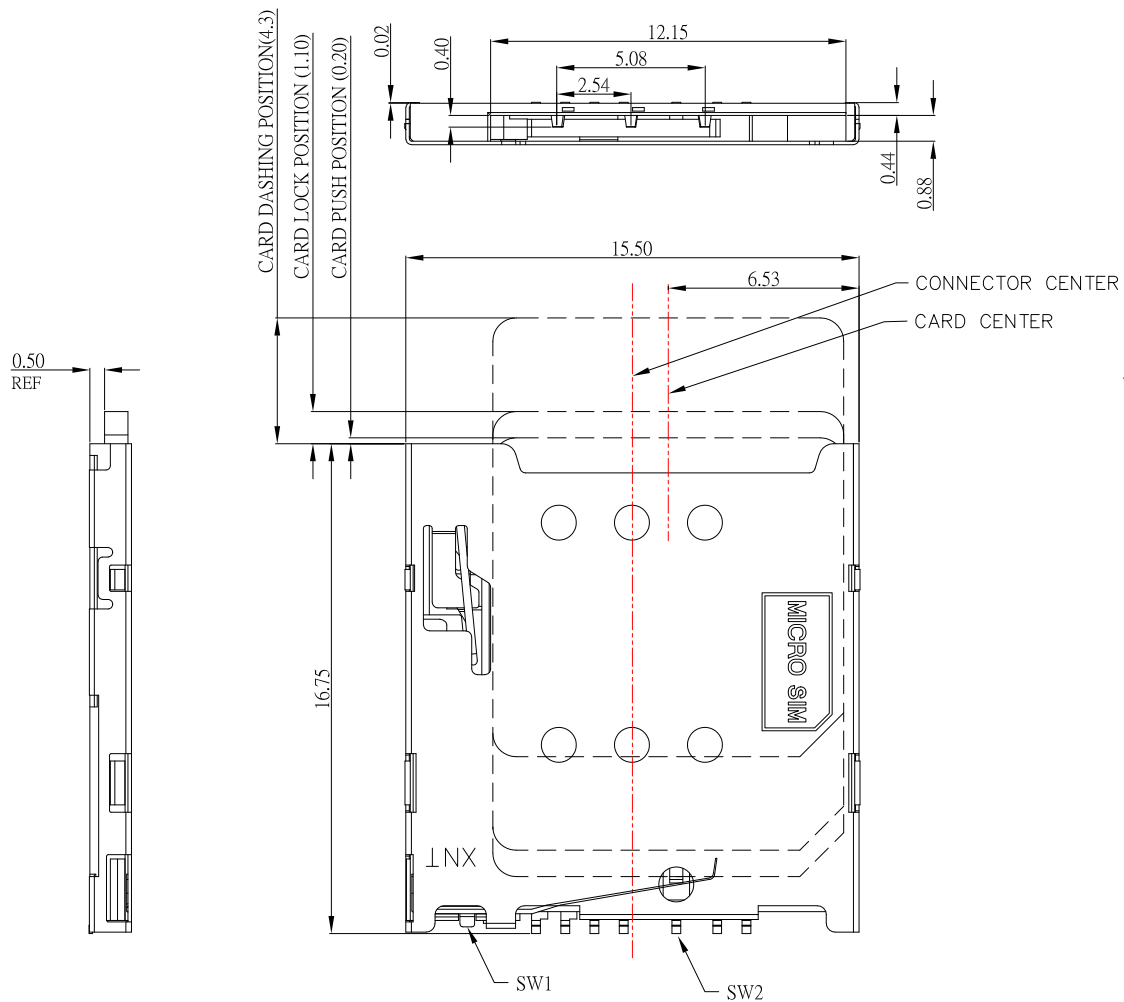
- 1.Operating Temperature: -40°C ~ +85°C.

**Material:**

- 1.Housing: LCP
- 2.Contact: Phosphor Bronze
- 3.Shell: Stainless Steel

**Finish:**

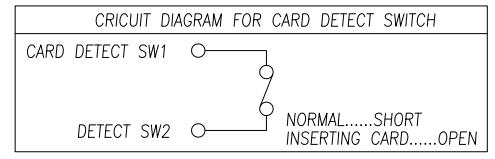
- 1.Contact: Plated Gold in Mating Area ;  
Tin Plated on Solder Balls ;  
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



**MSIM-0271G06-x-S267**

鍍層厚度 :

Blank : G/F
3 : 30u"



5	新增開關標示	Jack	082124
4	更新材質	Jack	062123
3	更新底部樣式	Neo	042922
2	更新底部樣式	Jack	080519
1	新增鍍層選項	Jack	032819
ITEM NO.	DESCRIPTION	DRAWN	DATE

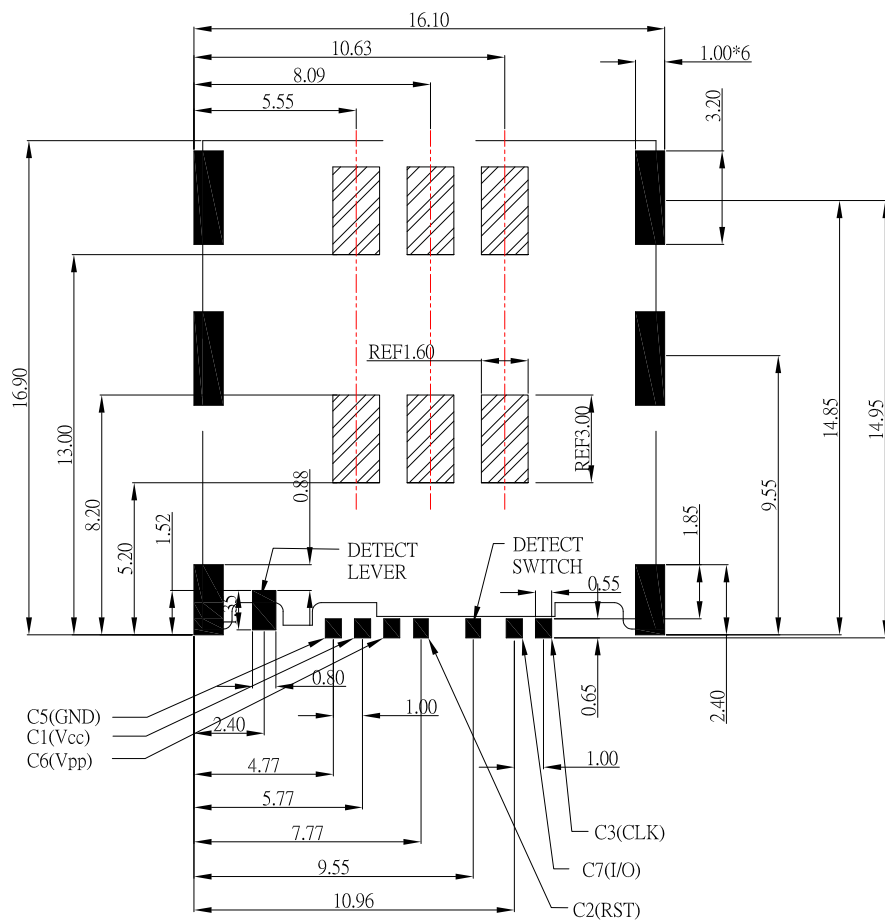


TOLERANCE UNLESS OTHERWISE STATED :

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3°

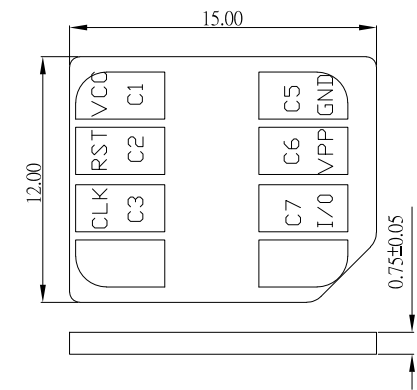
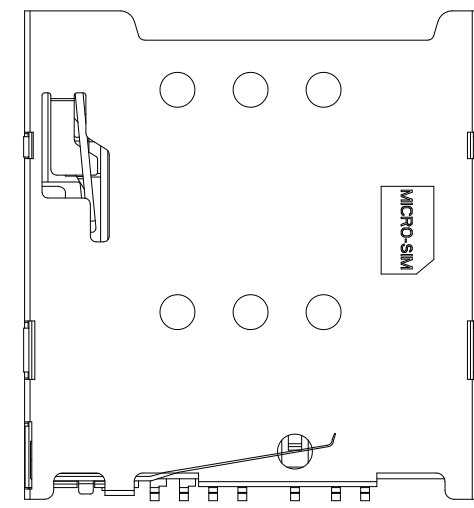
3RD. ANGEL'S

DRAWN BY:	DATE	MATL	TITLE	CONNECTOR
Jack Lu	08/21/24			
CHECKED BY:	DATE	FINISH	MODLE	MICRO SIM PUSH. H142 防呆型
Jacky Chen	08/21/24			
APPROVED BY:	DATE	SCALE	DWG NO.	MSIM-0271G06-x-S267
Tony Kao	08/21/24	1 : 1		
		SHEET NO.	PART NO.	MSIM-0271G06-x-S267
		1 of 2		



PCB 線路禁止區域  
 PCB AREA

RECOMMENDED PCB LAYOUT



MICRO SIM CARD

5	新增開關標示	Jack	082124
4	更新材質	Jack	062123
3	更新底部樣式	Neo	042922
2	更新底部樣式	Jack	080519
1	新增鍍層選項	Jack	032819
ITEM NO.	DESCRIPTION	DRAWN	DATE

**東莞市高迪電子有限公司**  
**DONG GUAN GAO DI ELECTRONICS CO., LTD**

TOLERANCE UNLESS OTHERWISE STATED :  
 Up to 5 ±0.2  
 Above 5 ~ 15 ±0.3  
 Above 15 ~ 30 ±0.4  
 Above 30 ~ 50 ±0.5  
 Angle ±0.3°

3RD. ANGEL'S



UNITS

MM

DRAWN BY:	DATE	MATL	TITLE	CONNECTOR
Jack Lu	08/21/24			
CHECKED BY:	DATE	FINISH	MODLE	MICRO SIM PUSH. H142 防呆型
Jacky Chen	08/21/24			
APPROVED BY:	DATE	SCALE	DWG NO.	MSIM-0271G06-x-S267
Tony Kao	08/21/24	1 : 1		
		SHEET NO.	PART NO.	MSIM-0271G06-x-S267
		2 of 2		
			SIZE	A4
			VER	R5